HEF4516B

Binary up/down counter Rev. 7 — 11 November 2011

Product data sheet

1. **General description**

The HEF4516B is an edge-triggered synchronous 4-bit binary up/down counter with a clock input (CP), an up/down count control input (UP/DN), an active LOW count enable input (CE), an asynchronous active HIGH parallel load input (PL), four parallel inputs (D0 to D3), four parallel outputs (Q0 to Q3), an active LOW terminal count output (TC), and an overriding asynchronous master reset input (MR).

Information on D0 to D3 is loaded into the counter while PL is HIGH, independent of all other input conditions except for MR which must be LOW. When PL and CE are LOW, the counter changes on the LOW-to-HIGH transition of CP. Input UP/DN determines the direction of the count, counting up when HIGH and counting down when LOW. When counting up, TC is LOW when Q0 and Q3 are HIGH and CE is LOW. When counting down, TC is LOW when Q0 to Q3 and CE are LOW. A HIGH on MR resets the counter (Q0 to Q3 = LOW) independent of all other input conditions.

It operates over a recommended V_{DD} power supply range of 3 V to 15 V referenced to V_{SS} (usually ground). Unused inputs must be connected to V_{DD}, V_{SS}, or another input.

Features and benefits 2.

- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Specified from -40 °C to +85 °C
- Complies with JEDEC standard JESD 13-B

3. Ordering information

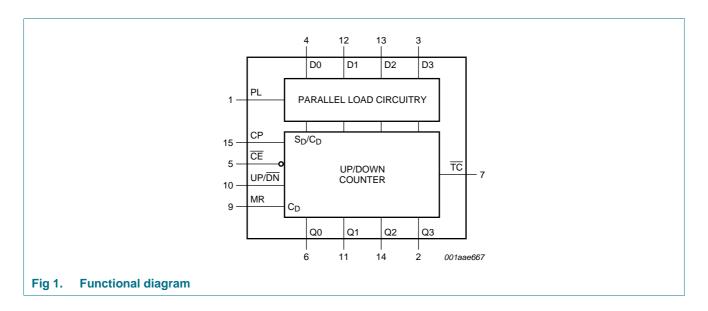
Table 1. **Ordering information**

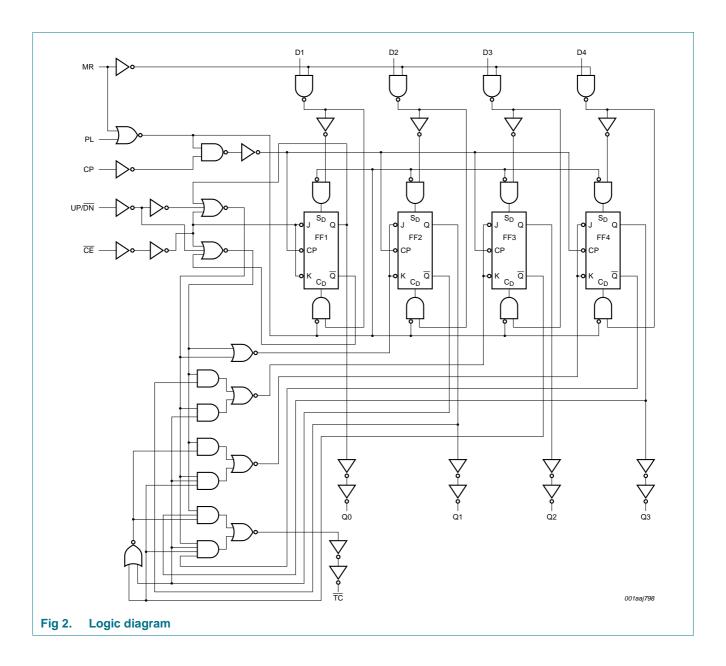
All types operate from -40 °C to +85 °C.

Type number	Package		
	Name	Description	Version
HEF4516BP	DIP16	plastic dual in-line package; 16-leads (300 mil)	SOT38-4
HEF4516BT	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1



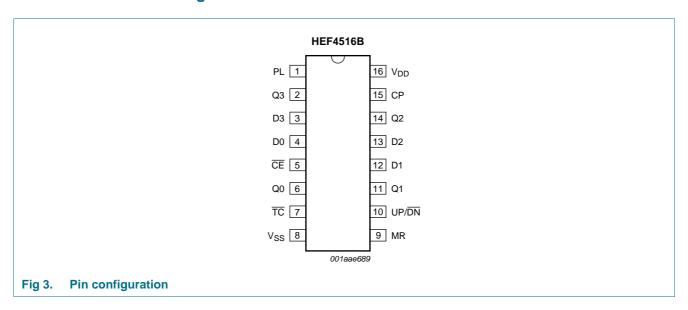
4. Functional diagram





5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

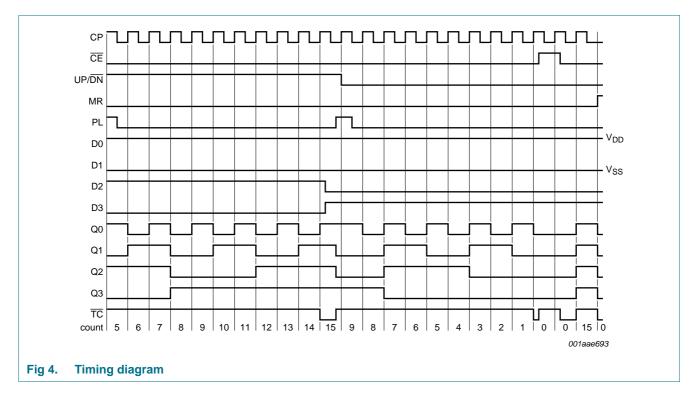
Symbol	Pin	Description
PL	1	parallel load input (active HIGH)
D0 to D3	4, 12, 13, 3	parallel input
CE	5	count enable input (active LOW)
Q0 to Q3	6, 11, 14, 2	parallel output
V _{SS}	8	ground supply voltage
TC	7	terminal count output (active LOW)
MR	9	master reset input
UP/DN	10	up/down count control input
СР	15	clock pulse input (LOW to HIGH, edge triggered)
V_{DD}	16	supply voltage

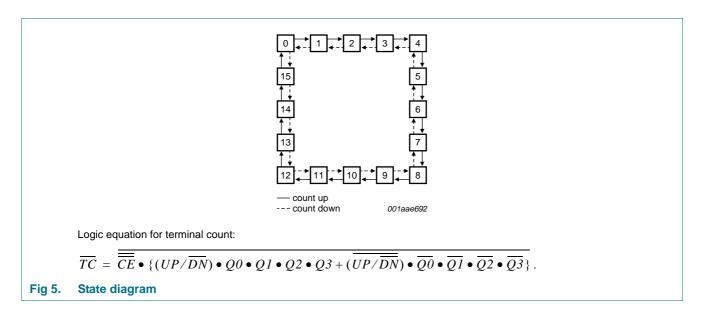
6. Functional description

Table 3. Function table[1]

MR	PL	UP/DN	CE	СР	MODE
L	Н	Χ	Χ	Χ	parallel load
L	L	Χ	Н	Χ	no change
L	L	L	L	↑	count down
L	L	Н	L	↑	count up
Н	Χ	Χ	Χ	Χ	reset

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; $\uparrow = positive-going transition$.





7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DD}	supply voltage		-0.5	+18	V
I _{IK}	input clamping current	$V_I < -0.5 \text{ V or } V_I > V_{DD} + 0.5 \text{ V}$	-	±10	mA
VI	input voltage		-0.5	$V_{DD} + 0.5$	V
l _{OK}	output clamping current	$V_O < -0.5 \text{ V or } V_O > V_{DD} + 0.5 \text{ V}$	-	±10	mA
I _{I/O}	input/output current		-	±10	mA
I_{DD}	supply current		-	50	mA
T _{stg}	storage temperature		-65	+150	°C
T _{amb}	ambient temperature		-40	+85	°C
P _{tot}	total power dissipation	DIP16 package	<u>[1]</u> -	750	mW
		SO16 package	[2] _	500	mW
Р	power dissipation	per output	-	100	mW

^[1] For DIP16 package: P_{tot} derates linearly with 12 mW/K above 70 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{DD}	supply voltage		3	-	15	V
VI	input voltage		0	-	V_{DD}	V
T _{amb}	ambient temperature	in free air	-40	-	+85	°C

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^[2] For SO16 package: Ptot derates linearly with 8 mW/K above 70 °C.

 Table 5.
 Recommended operating conditions ...continued

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{DD} = 5 V$	-	-	3.75	μs/V
		V _{DD} = 10 V	-	-	0.5	μs/V
		V _{DD} = 15 V	-	-	0.08	μs/V

9. Static characteristics

Table 6. Static characteristics

 $V_{SS} = 0 \ V$; $V_I = V_{SS} \ or \ V_{DD} \ unless \ otherwise \ specified.$

Symbol	Parameter	Conditions	V_{DD}	T _{amb} =	–40 °C	T _{amb} =	= 25 °C	T _{amb} =	85 °C	Unit
				Min	Max	Min	Max	Min	Max	
V_{IH}	HIGH-level input voltage	$ I_{O} < 1 \mu A$	5 V	3.5	-	3.5	-	3.5	-	V
			10 V	7.0	-	7.0	-	7.0	-	V
			15 V	11.0	-	11.0	-	11.0	-	V
V_{IL}	LOW-level input voltage	$ I_{O} < 1 \mu A$	5 V	-	1.5	-	1.5	-	1.5	V
			10 V	-	3.0	-	3.0	-	3.0	V
			15 V	-	4.0	-	4.0	-	4.0	V
V _{OH}	HIGH-level output voltage		5 V	4.95	-	4.95	-	4.95	-	V
		$V_I = V_{SS}$ or V_{DD}	10 V	9.95	-	9.95	-	9.95	-	V
			15 V	14.95	-	14.95	-	14.95	-	V
V_{OL}	LOW-level output voltage	$ I_O $ < 1 μ A; V_I = V_{SS} or V_{DD}	5 V	-	0.05	-	0.05	-	0.05	V
			10 V	-	0.05	-	0.05	-	0.05	V
			15 V	-	0.05	-	0.05	-	0.05	V
I _{OH}	HIGH-level output current	$V_0 = 2.5 \text{ V}$	5 V	-	-1.7	-	-1.4	-	−1.1 m/	mΑ
ЮН		V _O = 4.6 V	5 V	-	-0.52	-	-0.44	-	-0.36	mΑ
		V _O = 9.5 V	10 V	-	-1.3	-	-1.1	-	-0.9	mΑ
		V _O = 13.5 V	15 V	-	-3.6	-	-3.0	-	-2.4	mΑ
I _{OL}	LOW-level output current	V _O = 0.4 V	5 V	0.52	-	0.44	-	0.36	-	mA
		V _O = 0.5 V	10 V	1.3	-	1.1	-	0.9	-	mA
		V _O = 1.5 V	15 V	3.6	-	3.0	-	2.4	-	mA
I _I	input leakage current	$V_{DD} = 15 \text{ V}$	15 V	-	±0.3	-	±0.3	-	±1.0	μΑ
I _{DD}	supply current	$I_{O} = 0 A;$	5 V	-	20	-	20	-	150	μΑ
		$V_I = V_{SS}$ or V_{DD}	10 V	-	40	-	40	-	300	μΑ
			15 V	-	80	-	80	-	600	μΑ
Cı	input capacitance		-	-	-	-	7.5	-	-	pF

10. Dynamic characteristics

Table 7. Dynamic characteristics

 $V_{SS} = 0 \text{ V; } T_{amb} = 25 \text{ °C; for test circuit see }$ in less otherwise specified.

Propagation delay	PL to TC PL to TC	10 V 15 V 10 V 15 V 10 V 15 V 10 V 15 V 10 V 15 V 10 V 15 V	49 ns + (0.23 ns/pF)C _L 37 ns + (0.16 ns/pF)C _L 233 ns + (0.55 ns/pF)C _L 94 ns + (0.23 ns/pF)C _L 67 ns + (0.16 ns/pF)C _L 98 ns + (0.55 ns/pF)C _L 44 ns + (0.23 ns/pF)C _L 32 ns + (0.16 ns/pF)C _L 223 ns + (0.55 ns/pF)C _L 99 ns + (0.23 ns/pF)C _L 72 ns + (0.16 ns/pF)C _L 138 ns + (0.55 ns/pF)C _L 54 ns + (0.23 ns/pF)C _L 42 ns + (0.16 ns/pF)C _L	- - - - - - -	45 260 105 75 125 55 40 250 110 80 165 65	290 120 90 525 210 150 255 110 85 500 220 160 330 135	ns n
To V	PL to Qn PL to TC CE to TC	15 V 5 V 10 V 15 V 10 V 15 V 10 V 15 V 5 V 10 V 15 V 5 V	37 ns + (0.16 ns/pF)C _L 233 ns + (0.55 ns/pF)C _L 94 ns + (0.23 ns/pF)C _L 67 ns + (0.16 ns/pF)C _L 98 ns + (0.55 ns/pF)C _L 44 ns + (0.23 ns/pF)C _L 32 ns + (0.16 ns/pF)C _L 223 ns + (0.55 ns/pF)C _L 99 ns + (0.23 ns/pF)C _L 72 ns + (0.16 ns/pF)C _L 138 ns + (0.55 ns/pF)C _L 54 ns + (0.23 ns/pF)C _L 42 ns + (0.16 ns/pF)C _L	- - - - - - -	45 260 105 75 125 55 40 250 110 80 165 65	90 525 210 150 255 110 85 500 220 160 330 135	ns
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	PL to Qn PL to TC CE to TC	5 V 10 V 15 V 10 V 15 V 5 V 10 V 15 V 5 V 10 V 5 V	233 ns + (0.55 ns/pF)C _L 94 ns + (0.23 ns/pF)C _L 67 ns + (0.16 ns/pF)C _L 98 ns + (0.55 ns/pF)C _L 44 ns + (0.23 ns/pF)C _L 32 ns + (0.16 ns/pF)C _L 223 ns + (0.55 ns/pF)C _L 99 ns + (0.23 ns/pF)C _L 72 ns + (0.16 ns/pF)C _L 138 ns + (0.55 ns/pF)C _L 54 ns + (0.23 ns/pF)C _L 42 ns + (0.16 ns/pF)C _L	- - - - - - -	260 105 75 125 55 40 250 110 80 165 65	525 210 150 255 110 85 500 220 160 330 135	ns
The content of the	PL to Qn PL to TC CE to TC	10 V 15 V 10 V 15 V 5 V 10 V 15 V 5 V 10 V 15 V	94 ns + (0.23 ns/pF)C _L 67 ns + (0.16 ns/pF)C _L 98 ns + (0.55 ns/pF)C _L 44 ns + (0.23 ns/pF)C _L 32 ns + (0.16 ns/pF)C _L 223 ns + (0.55 ns/pF)C _L 99 ns + (0.23 ns/pF)C _L 72 ns + (0.16 ns/pF)C _L 138 ns + (0.55 ns/pF)C _L 54 ns + (0.23 ns/pF)C _L 42 ns + (0.16 ns/pF)C _L	- - - - - -	105 75 125 55 40 250 110 80 165	210 150 255 110 85 500 220 160 330 135	ns
PL to Qn	PL to TC	15 V 5 V 10 V 15 V 10 V 15 V 10 V 15 V 5 V	67 ns + (0.16 ns/pF)C _L 98 ns + (0.55 ns/pF)C _L 44 ns + (0.23 ns/pF)C _L 32 ns + (0.16 ns/pF)C _L 223 ns + (0.55 ns/pF)C _L 99 ns + (0.23 ns/pF)C _L 72 ns + (0.16 ns/pF)C _L 138 ns + (0.55 ns/pF)C _L 54 ns + (0.23 ns/pF)C _L 42 ns + (0.16 ns/pF)C _L	- - - - - -	75 125 55 40 250 110 80 165 65	150 255 110 85 500 220 160 330 135	ns
$ \begin{array}{c} \text{PL to Qn} \\ & \begin{array}{c} 5 \ \text{V} \\ \\ 10 \ \text{V} \\ \\ \end{array} \begin{array}{c} 44 \ \text{ns} + (0.23 \ \text{ns/pF)C}_L \\ \\ \end{array} \begin{array}{c} - \\ \\ \end{array} \begin{array}{c} 55 \\ \\ \end{array} \\ \begin{array}{c} 15 \ \text{V} \\ \end{array} \begin{array}{c} 32 \ \text{ns} + (0.16 \ \text{ns/pF)C}_L \\ \\ \end{array} \begin{array}{c} - \\ \end{array} \begin{array}{c} - \\ \end{array} \begin{array}{c} 40 \\ \\ \end{array} \\ \begin{array}{c} \text{PL to TC} \\ \end{array} \begin{array}{c} 5 \ \text{V} \\ \end{array} \begin{array}{c} 223 \ \text{ns} + (0.55 \ \text{ns/pF)C}_L \\ \\ \end{array} \begin{array}{c} - \\ \end{array} \begin{array}{c} - \\ \end{array} \begin{array}{c} 250 \\ \\ \end{array} \\ \begin{array}{c} 15 \ \text{V} \\ \end{array} \begin{array}{c} 223 \ \text{ns} + (0.55 \ \text{ns/pF)C}_L \\ \end{array} \begin{array}{c} - \\ \end{array} \begin{array}{c} - \\ \end{array} \begin{array}{c} 250 \\ \\ \end{array} \\ \begin{array}{c} 15 \ \text{V} \\ \end{array} \begin{array}{c} 72 \ \text{ns} + (0.16 \ \text{ns/pF)C}_L \\ \end{array} \begin{array}{c} - \\ \end{array} \begin{array}{c} - \\ \end{array} \begin{array}{c} 80 \\ \\ \end{array} \\ \begin{array}{c} \text{TC} \\ \end{array} \begin{array}$	PL to TC	5 V 10 V 15 V 10 V 15 V 5 V 10 V 15 V 5 V	98 ns + (0.55 ns/pF)C _L 44 ns + (0.23 ns/pF)C _L 32 ns + (0.16 ns/pF)C _L 223 ns + (0.55 ns/pF)C _L 99 ns + (0.23 ns/pF)C _L 72 ns + (0.16 ns/pF)C _L 138 ns + (0.55 ns/pF)C _L 54 ns + (0.23 ns/pF)C _L 42 ns + (0.16 ns/pF)C _L	- - - - -	125 55 40 250 110 80 165 65	255 110 85 500 220 160 330 135	ns ns ns ns ns ns ns ns ns
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	PL to TC	10 V 15 V 5 V 10 V 15 V 10 V 15 V 5 V	44 ns + (0.23 ns/pF)C _L 32 ns + (0.16 ns/pF)C _L 223 ns + (0.55 ns/pF)C _L 99 ns + (0.23 ns/pF)C _L 72 ns + (0.16 ns/pF)C _L 138 ns + (0.55 ns/pF)C _L 54 ns + (0.23 ns/pF)C _L 42 ns + (0.16 ns/pF)C _L	- - - - -	55 40 250 110 80 165 65	110 85 500 220 160 330 135	ns ns ns ns ns ns ns
$\begin{array}{c} & 15 \ V \\ & 32 \ ns + (0.16 \ ns/pF)C_L \\ & 5 \ V \\ & 223 \ ns + (0.55 \ ns/pF)C_L \\ & - \\ & 250 \\ \hline 10 \ V \\ & 99 \ ns + (0.23 \ ns/pF)C_L \\ & - \\ & 150 \ V \\ & 72 \ ns + (0.16 \ ns/pF)C_L \\ & - \\ & 165 \\ \hline 15 \ V \\ & 72 \ ns + (0.16 \ ns/pF)C_L \\ & - \\ & 100 \ V \\ & 54 \ ns + (0.23 \ ns/pF)C_L \\ & - \\ & 150 \ V \\ & 138 \ ns + (0.23 \ ns/pF)C_L \\ & - \\ & 150 \ V \\ & 178 \ ns + (0.23 \ ns/pF)C_L \\ & - \\ & 150 \ V \\ & 178 \ ns + (0.23 \ ns/pF)C_L \\ & - \\ & 150 \ V \\ & 178 \ ns + (0.23 \ ns/pF)C_L \\ & - \\ & 150 \ V \\ & 178 \ ns + (0.16 \ ns/pF)C_L \\ & - \\ & 150 \ V \\ & 110 \ V \\ & 54 \ ns + (0.23 \ ns/pF)C_L \\ & - \\ & 150 \ V \\ $	CE to TC	15 V 5 V 10 V 15 V 5 V 10 V 15 V	32 ns + (0.16 ns/pF)C _L 223 ns + (0.55 ns/pF)C _L 99 ns + (0.23 ns/pF)C _L 72 ns + (0.16 ns/pF)C _L 138 ns + (0.55 ns/pF)C _L 54 ns + (0.23 ns/pF)C _L 42 ns + (0.16 ns/pF)C _L	- - -	40 250 110 80 165 65	85 500 220 160 330 135	ns ns ns ns ns
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	CE to TC	5 V 10 V 15 V 5 V 10 V 15 V	223 ns + (0.55 ns/pF)C _L 99 ns + (0.23 ns/pF)C _L 72 ns + (0.16 ns/pF)C _L 138 ns + (0.55 ns/pF)C _L 54 ns + (0.23 ns/pF)C _L 42 ns + (0.16 ns/pF)C _L	- - -	250 110 80 165 65	500 220 160 330 135	ns ns ns ns
$\frac{10 \text{ V}}{15 \text{ V}} = \frac{99 \text{ ns} + (0.23 \text{ ns/pF})\text{C}_L}{72 \text{ ns} + (0.16 \text{ ns/pF})\text{C}_L} - \frac{110 \text{ Ns}}{80}$ $\frac{\overline{\text{CE}}}{15 \text{ V}} = \frac{5 \text{ V}}{138 \text{ ns} + (0.55 \text{ ns/pF})\text{C}_L} - \frac{80 \text{ Ns}}{165 \text{ ns/pF}} = \frac{65 \text{ Ns}}{165 \text{ Ns}} = \frac{110 \text{ V}}{10 \text{ V}} = \frac{110 \text{ V}}{54 \text{ ns} + (0.23 \text{ ns/pF})\text{C}_L} - \frac{65 \text{ Ns}}{15 \text{ V}} = \frac{110 \text{ V}}{178 \text{ ns} + (0.16 \text{ ns/pF})\text{C}_L} - \frac{110 \text{ V}}{10 \text{ V}} = \frac{110 \text{ V}}{110 \text{ Ns/pF}} = \frac{110 \text{ V}}{110 \text{ V}} = \frac{110 \text{ V}}{110 \text{ Ns/pF}} = \frac{110 \text{ V}}{110 \text{ Ns/pF}} = \frac{110 \text{ V}}{110 \text{ V}} = \frac{110 \text{ V}}{110 \text{ Ns/pF}} = \frac{110 \text{ V}}{110 \text{ V}} = \frac{110 \text{ V}}{110 \text{ Ns/pF}} = \frac{110 \text{ V}}{110 \text{ Ns/pF}} = \frac{110 \text{ V}}{110 \text{ V}} = \frac{110 \text{ V}}{110 \text{ Ns/pF}} = \frac{110 \text{ V}}{110 \text{ V}} = \frac{110 \text{ V}}{110 \text{ Ns/pF}} = \frac{110 \text{ V}}{110 \text{ V}} = \frac{110 \text{ V}}{110 \text{ Ns/pF}} = \frac{110 \text{ V}}{110 \text{ V}} = \frac{110 \text{ V}}{110 \text{ Ns/pF}} = \frac{110 \text{ V}}{110 \text{ V}} = \frac{110 \text{ V}}{110 \text{ Ns/pF}} = \frac{110 \text{ V}}{110 \text{ V}} = \frac{110 \text{ V}}{110 \text{ Ns/pF}} = \frac{110 \text{ V}}{110 \text{ V}} = \frac{110 \text{ V}}{110 \text{ Ns/pF}} = \frac{110 \text{ V}}{110 \text{ V}} = \frac{110 \text{ V}}{110 \text{ Ns/pF}} = \frac{110 \text{ V}}{110 \text{ V}} = \frac{110 \text{ V}}{110 \text{ Ns/pF}} = \frac{110 \text{ V}}{110 \text{ V}} = \frac{110 \text{ V}}{110 \text{ Ns/pF}} = \frac{110 \text{ V}}{110 \text{ V}} = \frac{110 \text{ V}}{110 \text{ Ns/pF}} = \frac{110 \text{ V}}{110 \text{ V}} = \frac{110 \text{ V}}{110 \text{ Ns/pF}} = \frac{110 \text{ V}}{110 \text{ V}} = 110 \text{ $	CE to TC	10 V 15 V 5 V 10 V 15 V	99 ns + (0.23 ns/pF)C _L 72 ns + (0.16 ns/pF)C _L 138 ns + (0.55 ns/pF)C _L 54 ns + (0.23 ns/pF)C _L 42 ns + (0.16 ns/pF)C _L	- -	110 80 165 65	220 160 330 135	ns ns ns
$\overline{CE} \text{ to } \overline{TC} = \frac{15 \text{ V}}{5 \text{ V}} = \frac{72 \text{ ns} + (0.16 \text{ ns/pF})C_L}{10 \text{ V}} = \frac{80 \text{ N}}{138 \text{ ns}} + \frac{(0.55 \text{ ns/pF})C_L}{10 \text{ V}} = \frac{165 \text{ N}}{15 \text{ N}} = \frac{165 \text{ N}}{15 \text{ V}} = \frac{165 \text{ N}}{15 \text{ N}} = \frac{165 \text{ N}}{15 \text{ V}} = \frac{165 \text{ N}}{15 \text{ N}} = \frac{165 \text{ N}}{15 \text{ N}} = \frac{165 \text{ N}}{15 \text{ V}} = \frac{165 \text{ N}}{15 \text{ N}} = \frac{165 \text{ N}}{15 $		15 V 5 V 10 V 15 V 5 V	72 ns + $(0.16 \text{ ns/pF})C_L$ 138 ns + $(0.55 \text{ ns/pF})C_L$ 54 ns + $(0.23 \text{ ns/pF})C_L$ 42 ns + $(0.16 \text{ ns/pF})C_L$	- -	80 165 65	160 330 135	ns ns ns
$ \frac{\overline{CE} \text{ to } \overline{TC}}{10 \text{ V}} = \frac{5 \text{ V}}{138 \text{ ns}} + (0.55 \text{ ns/pF})C_L - \frac{165}{10 \text{ V}} \\ \frac{10 \text{ V}}{54 \text{ ns}} + (0.23 \text{ ns/pF})C_L - \frac{65}{50 \text{ N}} \\ \frac{15 \text{ V}}{150 \text{ V}} = \frac{42 \text{ ns}}{160 \text{ Ns/pF}} + \frac{165}{50 \text{ Ns/pF}} \\ \frac{10 \text{ V}}{10 \text{ V}} = \frac{50 \text{ Ns/pF}}{10 \text{ V}} + \frac{178 \text{ ns}}{10 \text{ Ns/pF}} + \frac{178 \text{ Ns}}{100 \text{ Ns/pF}} + \frac{178 \text{ Ns}$		5 V 10 V 15 V 5 V	138 ns + (0.55 ns/pF)C _L 54 ns + (0.23 ns/pF)C _L 42 ns + (0.16 ns/pF)C _L	-	165 65	330 135	ns ns
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$		10 V 15 V 5 V	54 ns + (0.23 ns/pF)C _L 42 ns + (0.16 ns/pF)C _L	-	65	135	ns
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	MR to Qn, TC	15 V 5 V	42 ns + (0.16 ns/pF)C _L	-			
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	MR to Qn, TC	5 V	, , , -	-	50	100	ns
10 V 54 ns + (0.23 ns/pF)C _L - 65 15 V 37 ns + (0.16 ns/pF)C _L - 45 15 V 11 128 ns + (0.55 ns/pF)C _L - 155 16 V 54 ns + (0.23 ns/pF)C _L - 65 15 V 54 ns + (0.23 ns/pF)C _L - 65 15 V 37 ns + (0.16 ns/pF)C _L - 45 16 V 153 ns + (0.55 ns/pF)C _L - 180 16 V 64 ns + (0.23 ns/pF)C _L - 75 16 V 47 ns + (0.16 ns/pF)C _L - 55	MR to Qn, TC		178 ns + (0.55 ns/pF)C _L			. 50	-
15 V 37 ns + (0.16 ns/pF)C _L - 45 EPLH LOW to HIGH propagation delay CP to Qn 10 V 54 ns + (0.23 ns/pF)C _L - 65 15 V 37 ns + (0.16 ns/pF)C _L - 45 CP to TC 5 V 153 ns + (0.55 ns/pF)C _L - 180 10 V 64 ns + (0.23 ns/pF)C _L - 75 15 V 47 ns + (0.16 ns/pF)C _L - 55		40.17		-	205	405	ns
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$		10 V	54 ns + (0.23 ns/pF)C _L	-	65	130	ns
		15 V	37 ns + (0.16 ns/pF)C _L	-	45	85	ns
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	CP to Qn	5 V	128 ns + (0.55 ns/pF)C _L	-	155	310	ns
CP to $\overline{\text{TC}}$ 5 V 153 ns + (0.55 ns/pF)C _L - 180 10 V 64 ns + (0.23 ns/pF)C _L - 75 15 V 47 ns + (0.16 ns/pF)C _L - 55		10 V	54 ns + (0.23 ns/pF)C _L	-	65	130	ns
10 V 64 ns + $(0.23 \text{ ns/pF})C_L$ - 75 15 V 47 ns + $(0.16 \text{ ns/pF})C_L$ - 55		15 V	37 ns + (0.16 ns/pF)C _L	-	45	90	ns
15 V 47 ns + $(0.16 \text{ ns/pF})C_L$ - 55	CP to TC	5 V	153 ns + (0.55 ns/pF)C _L	-	180	360	ns
		10 V	64 ns + (0.23 ns/pF)C _L	-	75	150	ns
DI to On 5 \		15 V	47 ns + (0.16 ns/pF)C _L	-	55	115	ns
PL 10 Q11 5 V 145 115 + (0.55 115/PF)CL - 170	L to Qn	5 V	143 ns + (0.55 ns/pF)C _L	-	170	340	ns
10 V 59 ns + $(0.23 \text{ ns/pF})C_L$ - 70		10 V	59 ns + (0.23 ns/pF)C _L	-	70	140	ns
15 V 42 ns + $(0.16 \text{ ns/pF})C_L$ - 50		15 V	42 ns + (0.16 ns/pF)C _L	-	50	105	ns
PL to $\overline{\text{TC}}$ 5 V 223 ns + (0.55 ns/pF)C _L - 250	PL to TC	5 V	223 ns + (0.55 ns/pF)C _L	-	250	500	ns
10 V 99 ns + (0.23 ns/pF)C _L - 110		10 V	99 ns + (0.23 ns/pF)C _L	-	110	220	ns
15 V 72 ns + $(0.16 \text{ ns/pF})C_L$ - 80		15 V	72 ns + (0.16 ns/pF)C _L	-	80	160	ns
$\overline{\text{CE}}$ to $\overline{\text{TC}}$ 5 V 118 ns + (0.55 ns/pF)C _L - 145	CE to TC	5 V	118 ns + (0.55 ns/pF)C _L	-	145	290	ns
10 V 49 ns + $(0.23 \text{ ns/pF})C_L$ - 60		10 V	49 ns + (0.23 ns/pF)C _L	-	60	125	ns
15 V 37 ns + $(0.16 \text{ ns/pF})C_L$ - 45		15 V	37 ns + (0.16 ns/pF)C _L	-	45	95	ns
MR to $\overline{\text{TC}}$ 5 V 198 ns + (0.55 ns/pF)C _L - 225	∕IR to TC	5 V	198 ns + (0.55 ns/pF)C _L	-	225	450	ns
10 V $64 \text{ ns} + (0.23 \text{ ns/pF})C_L$ - 75		10 V	64 ns + (0.23 ns/pF)C _L	-	75	150	ns
15 V 42 ns + $(0.16 \text{ ns/pF})C_L$ - 50		15 V	42 ns + (0.16 ns/pF)C _L	-	50	100	ns

 Table 7.
 Dynamic characteristics ...continued

 $V_{SS} = 0 \text{ V; } T_{amb} = 25 \text{ °C; for test circuit see }$ in less otherwise specified.

Symbol	Parameter	Conditions	V_{DD}		Extrapolation formula	Min	Тур	Max	Unit
t _t	transition time		5 V	[1]	10 ns + (1.00 ns/pF)C _L	-	60	120	ns
			10 V		9 ns + (0.42 ns/pF)C _L	-	30	60	ns
			15 V		6 ns + (0.28 ns/pF)C _L	-	20	40	ns
f _{max}	maximum frequency	see Figure 6	5 V			3	6	-	MHz
			10 V			7	14	-	MHz
			15 V			9	18	-	MHz
t _W	pulse width	CP input LOW;	5 V			95	45	-	ns
		minimum width; see Figure 6	10 V			35	20	-	ns
		see <u>rigure o</u>	15 V			25	15	-	ns
		PL input HIGH;	5 V			105	55	-	ns
		minimum width; see Figure 7	10 V			45	25	-	ns
		see <u>rigure /</u>	15 V			35	15	-	ns
		MR input HIGH;	5 V			120	60	-	ns
		minimum width;	10 V			50	25	-	ns
		see Figure 7	15 V			40	20	-	ns ns ns ns MHz MHz MHz ns ns ns ns
t _{rec}	recovery time	MR input;	5 V			130	65	-	ns n
		see Figure 7	10 V			45	20	-	ns
			15 V			30	15	-	ns
		PL input;	5 V			150	75	-	ns
		see Figure 7	10 V			50	25	-	ns
			15 V			30	15	-	ns ns ns
t _{su}	set-up time	Dn to PL;	5 V			100	50		ns
		see Figure 7	10 V			50	25	-	ns
			15 V			40	20	-	ns
		UP/DN to CP;	5 V			250	125	-	ns
		see Figure 6	10 V			100	50	-	ns
			15 V			75	35	-	ns
		CE to CP;	5 V			120	60	-	ns
		see Figure 6	10 V			40	20	-	ns
			15 V			25	10	-	ns
t _h	hold time	Dn to PL;	5 V			+10	-40	-	ns
		see Figure 7	10 V			+5	-20	-	ns
			15 V			0	-20	-	ns
		UP/DN to CP;	5 V			+35	-90	-	ns
		see Figure 6	10 V			+15	-35	-	
			15 V			+15	-25	-	ns
		CE to CP;	5 V			+20	-40	-	
		see Figure 6	10 V			+5	-15	-	
			15 V			+5	-10	-	
			10 0			73	-10		113

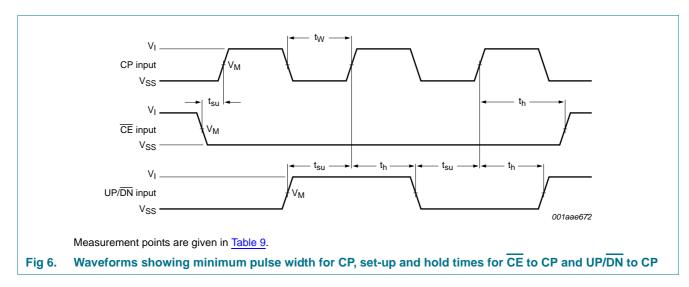
^[1] The typical values of the propagation delay and transition times are calculated from the extrapolation formulas shown (C_L in pF).

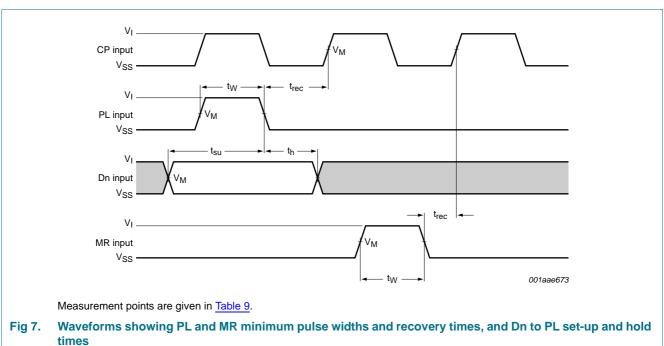
Table 8. Dynamic power dissipation P_D

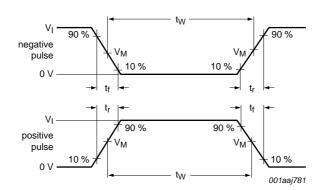
 P_D can be calculated from the formulas shown. $V_{SS} = 0$ V; $C_L = 50$ pF; $t_r = t_f \le 20$ ns; $T_{amb} = 25$ °C.

Symbol	Parameter	V_{DD}	Typical formula for P _D (μW)	Where:
P_D	dynamic power	5 V	$P_D = 1000 \times f_i + \Sigma (f_o \times C_L) \times V_{DD}^2$	f _i = input frequency in MHz;
diss	dissipation	10 V	$P_D = 4500 \times f_i + \Sigma (f_o \times C_L) \times V_{DD}^2$	f _o = output frequency in MHz;
		15 V	$P_D = 11200 \times f_i + \Sigma (f_o \times C_L) \times V_{DD}^2$	C_L = output load capacitance in pF;
		. (3 =/ 35		V_{DD} = supply voltage in V;
				$\Sigma(f_0 \times C_L)$ = sum of the outputs.

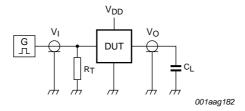
11. Waveforms







a. Input waveforms



b. Test circuit

Test data is given in Table 9.

Definitions for test circuit:

DUT = Device Under Test

C_L = Load capacitance including jig and probe capacitance;

 R_T = Termination resistance should be equal to output impedance Z_0 of the pulse generator.

Fig 8. Test circuit for measuring switching times

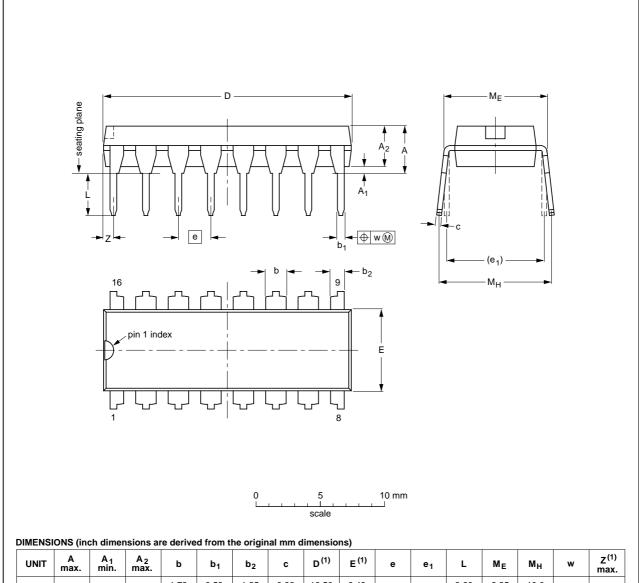
Table 9. Measurement points and test data

Supply voltage	Input			Load
	VI	V_{M}	t _r , t _f	CL
5 V to 15 V	V_{DD}	0.5V _I	≤ 20 ns	50 pF

12. Package outline

DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4



UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	b ₂	С	D ⁽¹⁾	E ⁽¹⁾	е	e ₁	L	ME	M _H	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.02	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.1	0.3	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.03

Note

1. Plastic or metal protrusions of 0.25 mm (0.01 inch) maximum per side are not included.

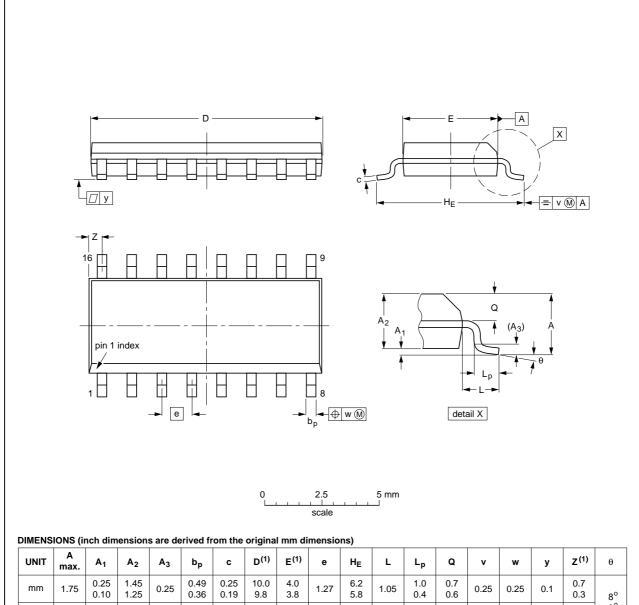
OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT38-4						95-01-14 03-02-13	

Fig 9. Package outline SOT38-4 (DIP16)

HEF4516B

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	٧	w	у	Z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01	1	0.0100 0.0075	0.39 0.38	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016		0.01	0.01	0.004	0.028 0.012	0°

Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT109-1	076E07	MS-012				99-12-27 03-02-19	

Fig 10. Package outline SOT109-1 (SO16)

13. Revision history

Table 10. Revision history

	•			
Document ID	Release date	Data sheet status	Change notice	Supersedes
HEF4516B v.7	20111111	Product data sheet	-	HEF4516B v.6
Modifications:	 Section App 	olications removed		
	 <u>Table 6</u>: I_{OF} 	_l minimum values changed t	o maximum	
HEF4516B v.6	20091211	Product data sheet	-	HEF4516B v.5
HEF4516B v.5	20090812	Product data sheet	-	HEF4516B v.4
HEF4516B v.4	20090312	Product data sheet	-	HEF4516B_CNV v.3
HEF4516B_CNV v.3	19950101	Product specification	-	HEF4516B_CNV v.2
HEF4516B_CNV v.2	19950101	Product specification	-	-

14. Legal information

14.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design
- [2] The term 'short data sheet' is explained in section "Definitions"
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